User’s Guide for the LMP90100 Evaluation Board with Sensor AFE Software

Table of Contents

1.0. INTRODUCTION ................................................................................................................2

2.0. EQUIPMENT .........................................................................................................................2

2.1. CONNECTION DIAGRAM .................................................................................................2

2.2. BOARD ASSEMBLY ...........................................................................................................4

3.0. EXAMPLE #1: QUICK START – DC READING .................................................................5

4.0. EXAMPLE #2: SHORTED INPUT AND CALIBRATION TEST ........................................10

5.0. EXAMPLE #3 - 3-WIRE RTD APPLICATION .....................................................................15

6.0. EXAMPLE #4: THERMOCOUPLE AND LM94022 APPLICATION .............................21

7.0. POWERING THE LMP90100EB ....................................................................................31

8.0. EVALUATING THE LMP90100 WITHOUT THE SPIO-4 BOARD ...............................31

9.0. INSTALLING THE LMP90100 SENSOR AFE SOFTWARE ............................................32

10.0. SCHEMATIC ......................................................................................................................36

11.0. LAYOUT ............................................................................................................................37

12.0. BOM ..................................................................................................................................39
1.0. Introduction

The LMP90100 Design Kit (consisting of the LMP90100 Evaluation Board, the SPIO-4 Digital Controller Board, the Sensor AFE software, and this user’s guide) is designed to ease evaluation and design-in of National Semiconductor’s LMP90100 24-bit Fully Programmable Low Power ΣΔ ADC with True Continuous Background Calibration.

Data capturing and static evaluations are simplified by connecting the SPIO-4 Digital Controller Board (SPIO-4 board) to a PC via USB and running the Sensor AFE software. The data capture board will generate the SPI signals to communicate to and capture data from the LMP90100. The user will also have the option to evaluate the LMP90100 without using the SPIO-4 board or the Sensor AFE software.

The LMP90100 will digitize the analog input, and the software will display these results in time domain and histogram. The software also allows customers to write to and read from registers, to calibrate the device or the system’s gain, offset, and scale settings, and most importantly, to configure and learn about the LMP90100.

This document describes the connection between the boards and PC, provides a quick start for a DC, shorted input, 3-wire RTD, and thermocouple/temperature sensor applications. This document also describes how to evaluate the LMP90100 with and without the SPIO-4 board and provides the schematic, board layouts, and BOM.

2.0. Equipment

1. LMP90100 evaluation board (NSID: LMP90100EB)
2. SPIO-4 digital controller board (NSID: SPIO-4)
3. PC with Sensor AFE software
4. Power supplies (optional) to source VA, VIO, VREFP, or VIN.
5. Multimeter (optional)
6. 3-wire RTD (optional)
7. Thermocouple (optional)

2.1. Connection Diagram

Figure 1 shows the connection between the LMP90100 Evaluation Board (LMP90100EB), SPIO-4 board, and a personal computer with the LMP90100 Sensor AFE software. LMP90100 can be powered using external power supplies or from the SPIO-4 board.
Figure 1 – Connection Diagram
2.2. Board Assembly
The schematic of the evaluation board can be seen in section 10.

Figure 2 – LMP90100 Evaluation Board Assembly
3.0. Example #1: Quick Start – DC Reading

The following procedures show a quick method to assemble the LMP90100EB and perform a quick DC voltage reading.

A. LMP90100 EB Jumper Connections
   1. The jumpers for this example application can be seen in Figure 3 and Table 1. Jumpers not shown can be left unpopulated.
   2. The SPIO-4 board is properly setup out of the box (no assembly required).
   3. The schematic for the LMP90100EB can be seen section 10.

<table>
<thead>
<tr>
<th>Jumpers</th>
<th>Pin</th>
<th>Purpose</th>
</tr>
</thead>
<tbody>
<tr>
<td>JP1: VA_EXT</td>
<td>P1-P2</td>
<td>Source VA externally</td>
</tr>
<tr>
<td>JP2: VIO_EXT</td>
<td>P1-P2</td>
<td>Source VIO externally</td>
</tr>
<tr>
<td>------------</td>
<td>------</td>
<td>----------------------</td>
</tr>
<tr>
<td>JP6</td>
<td>P1-P2</td>
<td>Connect VA supply to the LMP90100</td>
</tr>
<tr>
<td>JP7</td>
<td>P1-P2</td>
<td>Connect VIO supply to the LMP90100</td>
</tr>
<tr>
<td>JP10: VIN_JMP</td>
<td>P5-P6</td>
<td>Connect a DC input to VIN2</td>
</tr>
<tr>
<td>JP10: VIN_JMP</td>
<td>P7-P8</td>
<td>Connect a DC input to VIN3</td>
</tr>
<tr>
<td>JP13: VREF_JMP</td>
<td>P3-P4</td>
<td>VREFP1 = 4.1V from U4 (LM4140)</td>
</tr>
<tr>
<td>JP13: VREF_JMP</td>
<td>P9-P10</td>
<td>VREFN1 = ground</td>
</tr>
<tr>
<td>JP14: VREF_JMP</td>
<td>P1-P2</td>
<td>Connect VREFP1 source to the LMP90100</td>
</tr>
<tr>
<td>JP14: VREF_JMP</td>
<td>P3-P4</td>
<td>Connect VREFN1 source to the LMP90100</td>
</tr>
</tbody>
</table>

Table 1 - Jumpers for DC Measurement

B. **Installing/Opening the Software** - follow section 9.0 to install and open the LMP90100 Sensor AFE software.

C. **Connecting and Powering the Boards** – these steps have to be done in this order.
   1. Connect a 5.0V power supply to J1 (VA_EXT) and GND (J2). Don’t turn on the power supply yet.
   2. Connect a 5.0V power supply to J3 (VIO_EXT) and GND (J2). Don’t turn on the power supply yet.
   3. **Turn on** the power supply that is sourcing VA (J1), and then turn on the power supply that is sourcing VIO (J3).
   4. Connect the LMP90100EB’s JP12 to SPIO-4 Board’s J6 (pins 1-16). See Figure 4.

![Figure 4 – LMP90100EB-to-SPIO-4 Board Connection](image)

5. Connect SPIO-4 board to a PC via **USB**.
6. Use a multimeter to measure LMP90100EB’s JP6, JP7; they should all be approximately 5V. If they are not, check your power supplies and jumpers. Measure JP14.P2; it should be approximately 4.1V. If it’s not, check your jumpers and U4.

D. **Configuring the LMP90100 Using the Sensor AFE Software**
Follow the step-by-step instructions under the “HelpBar” mini-tab (left hand side of the GUI) to configure the LMP90100 for this example. These step-by-step instructions are discussed in details below, and the recommended configuration should look similar to the figure below.

**Figure 5 - Recommended LMP90100 Configuration for a DC Reading**

1. **Step 1:** Select a Sensor - select “DC” → “DC” since the input source is not a sensor.

2. **Step 2:** Configure Inputs – click on the “INPUT MUX” block to set “VINP = 000: VIN2” and “VINN = 001: VIN3”. Since VIN0 = (3/4) VREF1 and VIN1 = (1/4) VREF1, the measurement across this channel will be (1/2) VREF1.

3. **Step 3:** Source IB1/IB2? – this step can be ignored because neither IB1 nor IB2 is connected to the inputs.

4. **Step 4:** Select Reference – click on the “VREF MUX” block to choose “VREF_SEL = 0: VREF1”. Make sure the VREF1 value on the upper left hand side of the GUI is 4.1V (default).

5. **Step 5:** Set Gain – since VIN = (1/2) VREF1, the maximum gain that can be set is 2 (with buffer disabled). If the buffer is enabled, then the output might rail and enable the “OFLO_FLAGS” flag. In this case, set the gain to 1. Click on the “FGA” block, “PGA” block, or the “Gain” slider to select the gain.
6. Step 6: Set Buffer – click on the “BUFF” block to include or exclude the buffer from the signal path.

7. Step 7: Set Calibration - click on the “No Calibration” block to enable or disable calibration. Refer to the LMP90100 datasheet to more information on the LMP90100’s background calibration types and modes.

8. Step 8: Int/Ext CLK? – click on the “CLK MUX” block and make sure the internal clock is selected.

9. Step 9: Performance - click on the “Performance” mini-tab. This tab displays the Estimated Device Performance base on the block diagram that you’ve configured, as well as the Measured System Performance if you’ve connected a board and ran the LMP90100.

E. Capturing Data

1. Click on the “Measurement” tab and set the “Scan Mode” as follows:

   ![Scan Mode Settings](image)

   Figure 6 - Scan Mode Settings

2. Under the “Output Format” field, select Display as “Output Voltage (V)”

3. Under the “Stop Condition” field, select Run as “1000” samples.

4. Click on the “Run” button to view the output voltage results. A reading of approximately \(\frac{1}{2}(V_{REF1})\) should be plotted as seen in Figure 7.
Figure 7 - Results for Example #1 - DC Reading
4.0. Example #2: Shorted Input and Calibration Test

This example demonstrates LMP90100’s ability to calibrate for offset error.

A. LMP90100 EB Jumper Connections

1. Connect the LMP90100EB jumpers like the jumpers shown in the figure and table below. Jumpers not mentioned can be left unconnected.
2. The SPIO-4 board is properly setup out of the box (no assembly required).
3. The schematic for the LMP90100EB can be seen in section 10.

![Figure 8 – LMP90100EB Jumper Settings for the Shorted input and Calibration Test](image)

<table>
<thead>
<tr>
<th>Jumpers</th>
<th>Pin</th>
<th>Purpose</th>
</tr>
</thead>
<tbody>
<tr>
<td>JP1: VA_EXT</td>
<td>P2-P3</td>
<td>Source VA with the 5.0V from the SPIO-4 board.</td>
</tr>
<tr>
<td>JP2: VIO_EXT</td>
<td>P2-P3</td>
<td>Source VIO with the 5.0V from the SPIO-4 board.</td>
</tr>
<tr>
<td>JP4</td>
<td>P2-P3</td>
<td>Get 5.0V from the SPIO-4 board</td>
</tr>
<tr>
<td>JP6</td>
<td>P1-P2</td>
<td>Connect VA supply to the LMP90100</td>
</tr>
<tr>
<td>JP7</td>
<td>P1-P2</td>
<td>Connect VIO supply to the LMP90100</td>
</tr>
<tr>
<td>JP9</td>
<td>P1-P2</td>
<td>Force the odd pins of JP10 to be midscale (VREF1/2)</td>
</tr>
<tr>
<td>JP10: VIN JMP</td>
<td>P5-P6</td>
<td>Connect a DC (midscale) voltage to VIN2</td>
</tr>
<tr>
<td>JP13: VREF JMP1</td>
<td>P3-P4</td>
<td>VREFP1 = 4.1V from U4 (LM4140)</td>
</tr>
<tr>
<td>JP13: VREF JMP1</td>
<td>P9-P10</td>
<td>VREFN1 = ground</td>
</tr>
</tbody>
</table>
### Table 2 - Jumpers for the Shorted Input Measurement

<table>
<thead>
<tr>
<th>Jumper</th>
<th>Pin</th>
<th>Purpose</th>
</tr>
</thead>
<tbody>
<tr>
<td>JP14: VREF JMP2</td>
<td>P1-P2</td>
<td>Connect VREFP1 source to the LMP90100</td>
</tr>
<tr>
<td>JP14: VREF JMP2</td>
<td>P3-P4</td>
<td>Connect VREFN1 source to the LMP90100</td>
</tr>
</tbody>
</table>

**B. Installing/Opening the Software** – skip this step if it’s already done. If not, follow section 9.0 to install and open the LMP90100 Sensor AFE software.

**C. Connecting and Powering the Boards**

1. Connect the LMP90100EB to the SPIO-4 board as seen in Figure 4.
2. Connect SPIO-4 board to a PC via **USB**.
3. Use a multimeter to measure LMP90100EB’s JP6 and JP7; they should all be approximately 5V, and JP14.P2 should be 4.1V. If they are not, check your power supplies and jumpers.

**D. Configuring the LMP90100 Using the Sensor AFE Software**

Follow the step-by-step instructions under the “**HelpBar**” mini-tab (left hand side of the GUI) to configure the LMP90100 for this example. These step-by-step instructions are discussed in details below, and the recommended configuration should look similar to figure 9.

![Diagram](Figure 9 - Recommended LMP90100 Configuration for the Shorted Input and Calibration Test)

1. Step 1: Select a Sensor - select “**DC**” → “**DC**” since the input source is a DC voltage.
2. Step 2: Configure Inputs – click on the “INPUT MUX” block to set “VINP = 000: VIN2” and “VINN = 000: VIN2”. Since VINP = VINN, a reading of approximately 0V should be read.

3. Step 3: Source IB1/IB2? – *this step can be ignored because neither IB1 nor IB2 is connected to the inputs.*

4. Step 4: Select Reference – click on the “VREF MUX” block to choose “VREF_SEL = 0: VREF1”. On the left hand side of the GUI, change the VREF1 (left hand side of the GUI) value to 4.1V.

5. Step 5: Set Gain – since VIN ≈ 0V, the maximum gain that can be set is 128x. Click on the “FGA” block, “PGA” block, or the “Gain” slider to select the gain.

6. Step 6: Set Buffer – click on the “BUFF” block to include or exclude the buffer from the signal path.

7. Step 7: Set Calibration - the purpose of this example is to show how the LMP90100 removes the offset error using background calibration. Initially, disable the calibration by selecting “000: No Calibration” under the “No Calibration” block.

Refer to the LMP90100 datasheet to more information on the LMP90100’s background calibration types and modes.

8. Step 8: Int/Ext CLK? – click on the “CLK MUX” block and make sure the internal clock is selected.

9. Step 9: Performance - click on the “Performance” mini-tab. This tab displays the Estimated Device Performance base on the block diagram that you’ve configured, as well as the Measured System Performance if you’ve connected a board and ran the LMP90100.

E. Capturing Data without Calibration

1. Click on the “Measurement” tab and set the “Scan Mode” as follows:

   ![Scan Mode Settings](Figure 10 - Scan Mode Settings)

2. Under the “Output Format” field, select Display “Output Voltage (V)”

3. Under the “Stop Condition” field, select Run “500” samples.

4. Click on the “Run” button to view the output voltage results. A reading in the hundreds of uV should be plotted similar to Figure 11.
Figure 11 - Results for Shorted Input Test without Calibration

F. Capturing Data with Calibration

1. In the “Measurement” tab, go to “Quick Control → BGCAL_MODE” and change the background calibration to “001: Offset Cor / Gain Est”.
2. Click on the “Run” button again to view the output voltage results. A mean output reading closer to 0V should be plotted similar to Figure 12. This decrease in the mean output reading demonstrates the LMP90100 offset calibration feature.
Figure 12 - Results for Shorted Input Test with Calibration
5.0. Example #3 - 3-wire RTD Application

A 3-wire RTD has a typical configuration shown in Figure 13. This section will explain how to configure the LMP90100EB and software tool to evaluate a 3-wire RTD.

![Figure 13 - 3-Wire RTD Configuration](image)

A. LMP90100EB Jumper Connections

1. The jumper settings for this application are shown below. The jumpers not mentioned can be left unconnected.
2. The SPIO-4 board is properly setup out of the box (no assembly required).
3. The schematic for the LMP90100EB can be seen in section 10.
Figure 14 – Jumper Settings (Default) for the 3-wire RTD Example

<table>
<thead>
<tr>
<th>Jumpers</th>
<th>Pin</th>
<th>Purpose</th>
</tr>
</thead>
<tbody>
<tr>
<td>JP1: VA_EXT</td>
<td>P2-P3</td>
<td>Source VA with the 5.0V from the SPIO-4 board.</td>
</tr>
<tr>
<td>JP2: VIO_EXT</td>
<td>P2-P3</td>
<td>Source VIO with the 5.0V from the SPIO-4 board.</td>
</tr>
<tr>
<td>JP4</td>
<td>P2-P3</td>
<td>Get 5.0V from the SPIO-4 board</td>
</tr>
<tr>
<td>JP6</td>
<td>P1-P2</td>
<td>Connect VA supply to the LMP90100</td>
</tr>
<tr>
<td>JP7</td>
<td>P1-P2</td>
<td>Connect VIO supply to the LMP90100</td>
</tr>
<tr>
<td>JP11: RTD_JMP</td>
<td>P1-P2</td>
<td>Connect IB1 to the RTD</td>
</tr>
<tr>
<td>JP11: RTD_JMP</td>
<td>P3-P4</td>
<td>Connect the RTD to VIN0</td>
</tr>
<tr>
<td>JP11: RTD_JMP</td>
<td>P7-P8</td>
<td>Connect IB2 to the RTD</td>
</tr>
<tr>
<td>JP11: RTD_JMP</td>
<td>P9-P10</td>
<td>Connect the RTD to VIN1</td>
</tr>
<tr>
<td>JP11: RTD_JMP</td>
<td>P11-P12</td>
<td>Connect the RTD to VREFP2</td>
</tr>
<tr>
<td>JP11: RTD_JMP</td>
<td>P13-P14</td>
<td>Connect VREFN2 to ground</td>
</tr>
</tbody>
</table>

Table 3 – LMP90100EB Jumpers for the RTD Application
B. Installing/Opening the Software – skip this step if it’s already done. If not, follow section 9.0 to install and open the LMP90100 Sensor AFE software.

C. Connecting and Powering the Boards
1. Connect the LMP90100EB to the SPIO-4 board as seen in Figure 4.
2. Connect SPIO-4 board to a PC via USB.
3. Use a multimeter to measure LMP90100EB’s JP6 and JP7; they should all be approximately 5.0V. If they are not, check your power supplies and jumpers.

D. Connecting the Sensor to the LMP90100EB

![Figure 15 – Jumper Settings (Default) for the 3-wire RTD Example](image-url)

E. Configuring the LMP90100 Using the Sensor AFE Software

Follow the step-by-step instructions under the “HelpBar” mini-tab (left hand side of the GUI) to configure the LMP90100 for this example. These step-by-step instructions are discussed in details below, and the recommended configuration should look similar to Figure 16.
1. Step 1: Select a Sensor - select “RTD” → “PRTF-10-2-100-1/4-6-E”.

2. Step 2: Configure Inputs – click on the “INPUT MUX” block to set “VINP = 000: VIN0” and “VINN = 001: VIN1”. Click on the “Eval. Board Settings” button located next to the block diagram. This should open up a PDF of the schematic and calculation for this 3-wire RTD example.


4. Step 4: Select Reference – click on the “VREF MUX” block to choose “VREF_SEL = 1: VREF2”. Make sure the value for VREF2 (upper left hand side of the GUI) is 2.0V = [RREF * (IB1+IB2)] = [1k * (1mA + 1mA)].

5. Step 5: Set Gain – since VIN = 0.109 V at room temperature for IB1 = IB2 = 1000 uA, the maximum gain can be 16x. Click on the “FGA” block, “PGA” block, or the “Gain” slider to select the gain. *(For this exercise, the gain can be set to 1x).*

6. Step 6: Set Buffer – click on the “BUFF” block to include or exclude the buffer from the signal path. *(For this exercise, the buffer can be disabled).*
7. Step 7: Set Calibration - click on the “No Calibration” block to enable or disable calibration. Refer to the LMP90100 datasheet to more information on the LMP90100’s background calibration types and modes. *(For this exercise, the calibration can be OFF).*

8. Step 8: Int/Ext CLK? – click on the “CLK MUX” block and make sure the internal clock is selected.

9. Step 9: Performance - click on the “Performance” mini-tab. This tab displays the Estimated Device Performance base on the block diagram that you’ve configured, as well as the Measured System Performance if you’ve connected a board and ran the LMP90100.

F. Capturing Data

1. Click on the “Measurement” tab and set the “Scan Mode” as follows:

   ![Scan Mode Settings](image)

   **Figure 17 - Scan Mode Settings**

2. Under the “Output Format” field, select Display “Temperature (°C)”

3. Make sure the “Sensor Characteristics” is set as:

   ![Sensor Characteristics](image)

4. Under the “Stop Condition” field, select “Run Continuously”.

5. Click on the “Run” button to view the output temperature reading. A reading of approximately 23°C to 25°C (room temperature) should be plotted.
Figure 18 – Reading of Room Temperature Using the 3-Wire RTD
6.0. Example #4: Thermocouple and LM94022 Application

A. Thermocouple and Cold Junction Compensation Background

As described in section 17.6.2. of the LMP90100 datasheet, because a thermocouple can only measure a voltage difference and thus a temperature difference (relative temperature), it does not have the ability to measure absolute temperature. To determine the absolute temperature of the measured environment, a technique known as cold junction compensation (CJC) must be used.

In a CJC technique, the “cold” junction temperature, Tcold (Figure 19), is sensed by using an IC temperature sensor, such as the LM94022. The temperature sensor should be placed within close proximity of the reference junction. The LM94022 is placed underneath the thermocouple connector J4 on the LMP90100 evaluation board.

The technique to calculate for Thot using the CJC method can be found in the LMP90100 datasheet.

The Sensor AFE software does have the ability to display the relative thermocouple temperature using a Type K look-up-table (http://www.intech.co.nz/products/temperature/typek.html). In addition, if the LM94022 (or any other temperature sensors) is connected to the LMP90100, then the software can also read its temperature (Tcold). However, the user has to manually enter this Tcold value in the field located on the upper left hand side of the GUI. The software will use this T_board value to calculate for Thot.

B. Thermocouple and LM94022 Schematic on the LMP90100EB
The thermocouple and temperature sensor schematic of the LMP90100 Evaluation Board are shown below. The temperature sensor is a LM94022 and is located under the thermocouple connector (J4) to provide cold junction compensation. The thermocouple connector (J4) is made for use with a type K thermocouple. The following subsections will explain how to configure the LMP90100EB for the thermocouple and IC temperature sensor applications.

![Schematic Image]

Place LM94022 underneath thermocouple's connector (not underneath the board)

---

**Figure 20 – Thermocouple and Temperature Sensor Schematic**

**C. LMP90100EB Jumper Connections:**

1. The figure and table below show the LMP90100 evaluation board jumper settings for this thermocouple application. The jumpers not mentioned can be left unconnected.
2. The SPIO-4 board is properly setup out of the box (no assembly required).
3. The schematic for the LMP90100EB can be seen in section 10.
Table 4 – LMP90100EB Jumpers for the RTD Application

<table>
<thead>
<tr>
<th>Jumper(s)</th>
<th>Pin(s)</th>
<th>Purpose</th>
</tr>
</thead>
<tbody>
<tr>
<td>JP1: VA_EXT</td>
<td>P2-P3</td>
<td>Source VA with the 5.0V from the SPIO-4 board.</td>
</tr>
<tr>
<td>JP2: VIO_EXT</td>
<td>P2-P3</td>
<td>Source VIO with the 5.0V from the SPIO-4 board.</td>
</tr>
<tr>
<td>JP4</td>
<td>P2-P3</td>
<td>Get 5.0V from the SPIO-4 board</td>
</tr>
<tr>
<td>JP6</td>
<td>P1-P2</td>
<td>Connect VA supply to the LMP90100</td>
</tr>
<tr>
<td>JP7</td>
<td>P1-P2</td>
<td>Connect VIO supply to the LMP90100</td>
</tr>
<tr>
<td>JP5: TC JMP</td>
<td>P1-P2</td>
<td>Connect TCN to VIN3</td>
</tr>
<tr>
<td>JP5: TC JMP</td>
<td>P3-P4</td>
<td>Connect TCP to VIN4</td>
</tr>
<tr>
<td>JP3: LM94022_JMP</td>
<td>P1-P2</td>
<td>Connect the output of LM94022 to VIN5</td>
</tr>
<tr>
<td>JP13: VREF JMP1</td>
<td>P3-P4</td>
<td>VREFP1 = 4.1V from U4 (LM4140)</td>
</tr>
<tr>
<td>JP13: VREF JMP1</td>
<td>P9-P10</td>
<td>VREFN1 = ground</td>
</tr>
<tr>
<td>JP14: VREF JMP2</td>
<td>P1-P2</td>
<td>Connect VREFP1 source to the LMP90100</td>
</tr>
<tr>
<td>JP14: VREF JMP2</td>
<td>P3-P4</td>
<td>Connect VREFN1 source to the LMP90100</td>
</tr>
</tbody>
</table>

D. Installing/Opening the Software – skip this step if it’s already done. If not, follow section 9.0 to install and open the LMP90100 Sensor AFE software.

E. Connecting and Powering the Boards

1. Connect the LMP90100EB to the SPIO-4 board as seen in Figure 4.
2. Connect SPIO-4 board to a PC via **USB**.
3. Use a multimeter to measure LMP90100EB’s JP6, JP7, and JP14.P2; they should all be approximately 5V. If they are not, check your power supplies and jumpers.

**F. Connect a K type thermocouple to J4.** Note that the thermocouple’s positive input (TCP) = VIN4 and negative input (TCN) = VIN3.

**G. Configuring the LMP90100 for the LM94022 Using the Sensor AFE Software**

Follow the step-by-step instructions under the **“HelpBar”** mini-tab (left hand side of the GUI) to configure the LMP90100 for the LM94022 IC sensor. These step-by-step instructions are discussed in details below, and the recommended configuration should look similar to Figure 22.

![Figure 22 - Recommended LMP90100 Configuration for the LM94022](image)

1. Step 1: Select a Sensor – click on the “+” button to enter the **“Sensor Database”** tab. Select **“Analog” → “LM94022”**.

2. Step 2: Configure Inputs – click on the **“INPUT MUX”** block to set **“VINP = 101: VIN5”** and **“VINN = 111: VIN7”**. Click on the **“Eval. Board Settings”** button located next to the block diagram. This should open up a PDF of the schematic of the thermocouple and LM94022 application.

3. Step 3: Source IB1/IB2? – this step can be ignored because neither IB1 nor IB2 is connected to the inputs.
4. Step 4: Select Reference – click on the “VREF MUX” block to choose “VREF_SEL = 0: VREF1”. Make sure the value for VREF1 = 4.1V.

5. Step 5: Set Gain – click on the “FGA” block, “PGA” block, or the “Gain” slider to select the gain. The gain can be set to 1 in this example.

6. Step 6: Set Buffer – click on the “BUFF” block to include or exclude the buffer from the signal path. The buffer can be excluded from the signal path in this example.

7. Step 7: Set Calibration - click on the “No Calibration” block to enable or disable calibration. Refer to the LMP90100 datasheet to more information on the LMP90100’s background calibration types and modes. The calibration can be OFF for this example.

8. Step 8: Int/Ext CLK? – click on the “CLK MUX” block and make sure the internal clock is selected.

9. Step 9: Performance - click on the “Performance” mini-tab. This tab displays the Estimated Device Performance base on the block diagram that you’ve configured, as well as the Measured System Performance if you’ve connected a board and ran the LMP90100.

H. Configuring the LMP90100 for the Thermocouple Using the Sensor AFE Software

Follow the step-by-step instructions under the “HelpBar” mini-tab (left hand side of the GUI) to configure the LMP90100 for the thermocouple. These step-by-step instructions are discussed in details below, and the recommended configuration should look similar to the figure below.
1. Step 1: Select a Sensor - select “Thermocouple” → select the thermocouple of your choice or add your own thermocouple by clicking on “New”.

2. Step 2: Configure Inputs – click on the “INPUT MUX” block to set “VINP = 100: VIN4” and “VINN = 011: VIN3”. Click on the “Eval. Board Settings” button located next to the block diagram. This should open up a PDF of the schematic for a thermocouple.

3. Step 3: Source IB1/IB2? – this step can be ignored because neither IB1 nor IB2 is connected to the inputs.

4. Step 4: Select Reference – click on the “VREF MUX” block to choose “VREF_SEL = 0: VREF1”. Make sure the value for VREF1 = 4.1V.

5. Step 5: Set Gain – since the differential junction across a thermocouple is low, the maximum gain can be 128x. Click on the “FGA” block, “PGA” block, or the “Gain” slider to select the gain. In this example, the gain can be 1x.

6. Step 6: Set Buffer – click on the “BUFF” block to include or exclude the buffer from the signal path. The buffer can be excluded from the signal path in this example.

7. Step 7: Set Calibration - click on the “No Calibration” block to enable or disable calibration. Refer to the LMP90100 datasheet to more information on the LMP90100’s background calibration types and modes. In this example, the calibration can be OFF.
8. Step 8: Int/Ext CLK? – click on the “CLK MUX” block and make sure the internal clock is selected.

9. Step 9: Performance - click on the “Performance” mini-tab. This tab displays the Estimated Device Performance base on the block diagram that you’ve configured, as well as the Measured System Performance if you’ve connected a board and ran the LMP90100.

F. Capturing Data

1. Click on the “Measurement” tab and set the “Scan Mode” as follows:

   ![Figure 24 - Scan Mode Settings](image)

   2. Under the “Output Format” field, select Display “Temperature (C)”
   3. Under the “Run For” field, plot the “Selected Channel: CH0”
   4. Under the “Stop Condition” field, select Run “1000 Samples”.
   5. Click on the “Run” button to capture the temperature (Tcold) reading from the LM94022 (see figure below).
6. Enter the LM94022’s mean temperature (see red box in the figure above) in the “T_board” field located on the upper left hand side of the GUI. The software will use this “T_board” value to calculate for the thermocouple’s absolute temperature (T_hot).

If the LM94022 or any other temperature sensor is not connected to do cold junction compensation, then the user can still manually enter a Tcold value in the “T_board” field box.

7. In the Sensor Window, click on CH1 to read the thermocouple’s voltage and temperature.

8. In the “Measurement” tab, choose the “Output Format” as “Output Voltage (V)”, and click “Run” to capture the thermocouple relative voltage.
9. In the “Output Format” field, choose to Display “Rel. Temp (C)”. This shows the relative temperature of the thermocouple. This reading is not factoring in the cold junction compensation.

![Image of Thermocouple Relative Temperature Reading]

**Figure 28 – Thermocouple Relative Temperature Reading**

10. In the “Output Format” field, choose to Display “Abs. Temp (C)”. This uses the “T_board” temperature and factor in the cold junction compensation method to display the absolute temperature (Thot) of the thermocouple.
Figure 29 – Thermocouple Absolute Temperature Reading
7.0. Powering the LMP90100EB

There are two ways in which VA and VIO can be sourced: external supplies or SPIO-4 power.

If using external power supplies to source VA and VIO, then do the following:
1. Connect an external power supply to J1 for VA. Jumper pins 1 and 2 of JP1 to select this option.
2. Connect an external power supply to J2 for VIO. Jumper pins 1 and 2 of JP2 to select this option.
3. Jumper JP6 to connect the external power to VA.
4. Jumper JP7 to connect the external power to VIO.

If using the SPIO-4 power to source VA and VIO, then do the following:
1. Jumper pins 1 and 2 of JP4 to select 3.3V for VA and VIO, or jumper pins 2 and 3 of JP4 to select 5.0V for VA and VIO.
2. Jumper pins 2 and 3 of JP1 to select the SPIO-4 power for VA.
3. Jumper pins 2 and 3 of JP2 to select the SPIO-4 power for VIO.
4. Jumper JP6 to connect the SPIO-4 power to VA.
5. Jumper JP7 to connect the SPIO-4 power to VIO.

The schematic for the LMP90100EB can be seen in section 10.

8.0. Evaluating the LMP90100 without the SPIO-4 Board.

The SPIO-4 digital controller board is used to generate the SPI signals to communicate to the LMP90100. Without the SPIO-4 board, the Sensor AFE software for the LMP90100 cannot be used to capture and analyze data from the LMP90100EB.

If the SPIO-4 board is not available but LMP90100 evaluation is desirable, then connect your own SPI signals to J8 of the LMP90100EB as seen below.

![Figure 30 - LMP90100EB’s J8 for SPI Signals](image)

Refer to the LMP90100 datasheet for more information on the LMP90100’s SPI protocol.
9.0. Installing the LMP90100 Sensor AFE Software

Each Sensor AFE product will have its own software. To access the Sensor AFE software for LMP90100, follow the steps below.

1. Getting the Zip Files
   a. You can find the latest downloadable Sensor AFE software at www.ti.com/sensorafe → Tools
   b. Download the zip file onto your local hardrive. Unzip this folder.

2. Installing the Driver - skip this step if you don’t have the LMP90100EB and SPIO4 digital controller board.
   a. Connect the LMP9100EB to SPIO4 board
   b. Connect the SPIO4 board to your PC.
   c. Follow the steps below to install the driver:

   ![Found New Hardware Wizard]

   Welcome to the Found New Hardware Wizard

   Windows will search for current and updated software by looking on your computer, on the hardware installation CD, or on the Windows Update Website (with your permission). Read our privacy policy

   Can Windows connect to Windows Update to search for software?

   - [ ] Yes, this time only
   - [ ] Yes, now and every time I connect a device
   - [ ] No, not this time

   Click Next to continue.

   Figure 31 - Click on "No, not this time"
Figure 32 – Choose to “install from a list or specific location (Advanced)”

Figure 33 – Find the driver in the “NSC_USB_v1.0.8.0” folder
(it should be located in the unzipped folder)
Figure 34 – Waiting for the computer to install the driver
3. Open the un-zipped folder and click on “\texttt{imp90100.exe}” to start the software. If you don’t have the boards, you’ll get an error message. Ignore that error message and click “Ok” to continue.
10.0. Schematic

Figure 36 - LMP90100EB Schematic
11.0. Layout

Figure 37 - Layout – Top Layer
Figure 38 - Layout 3rd Layer
# BOM

<table>
<thead>
<tr>
<th>Item</th>
<th>Quantity</th>
<th>Reference</th>
<th>Value</th>
<th>Description</th>
<th>Source</th>
<th>Source Part #</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>5</td>
<td>C1,C7,C10,C22,C24</td>
<td>1.0 uF</td>
<td>CAP CER 1.0UF 10V Y5V 0603</td>
<td>Digikey</td>
<td>490-1585-1-ND</td>
</tr>
<tr>
<td>2</td>
<td>10</td>
<td>C2,C8,C11,C18,C19,C20, C21,C23,C29,C30</td>
<td>0.1 uF</td>
<td>CAP CER .1UF 0603</td>
<td>Digikey</td>
<td>490-4779-1-ND</td>
</tr>
<tr>
<td>3</td>
<td>4</td>
<td>C3,C5,C17,C26</td>
<td>10nF</td>
<td>CAP CER 10000PF 50V 10% X7R 0603</td>
<td>Digikey</td>
<td>490-1512-1-ND</td>
</tr>
<tr>
<td>4</td>
<td>3</td>
<td>C4,C12,C14</td>
<td>2.2uF</td>
<td>CAP CER 2.2UF 10V Y5V 0805</td>
<td>Digikey</td>
<td>490-1743-1-ND</td>
</tr>
<tr>
<td>5</td>
<td>3</td>
<td>C13,C27,C28</td>
<td>10 uF</td>
<td>CAP CER 10UF 10V Y5V 0805</td>
<td>Digikey</td>
<td>445-1371-1-ND</td>
</tr>
<tr>
<td>6</td>
<td>2</td>
<td>C15,C16</td>
<td>12pF</td>
<td>CAP 12PF 50V CERM CHIP 0805 SMD</td>
<td>Digikey</td>
<td>PCC120CNCT-ND</td>
</tr>
<tr>
<td>7</td>
<td>1</td>
<td>JP1</td>
<td>VA_SELECT</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>8</td>
<td>1</td>
<td>JP2</td>
<td>VIO_SELECT</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>9</td>
<td>1</td>
<td>JP3</td>
<td>LM94022 JMP</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>10</td>
<td>1</td>
<td>JP4</td>
<td>SPIO4_PWR_SELECT</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>11</td>
<td>1</td>
<td>JP5</td>
<td>TC_SEL</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>12</td>
<td>1</td>
<td>JP6</td>
<td>VA_JMP</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>13</td>
<td>1</td>
<td>JP7</td>
<td>VIO_JMP</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>14</td>
<td>1</td>
<td>JP8</td>
<td>GPIO_2_GND</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>15</td>
<td>1</td>
<td>JP9</td>
<td>VIN_SHORT</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>16</td>
<td>1</td>
<td>JP10</td>
<td>INPUT_SELECT</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>17</td>
<td>1</td>
<td>JP11</td>
<td>RTD_SELECT</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Sullins Connector</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>18</td>
<td>1</td>
<td>JP12</td>
<td>SPIO4 CONNECTOR</td>
<td>CONN HEADR BRKWAY .100 80POS R/A</td>
<td>Digikey</td>
<td>A34278-40-ND</td>
</tr>
<tr>
<td>19</td>
<td>1</td>
<td>JP13</td>
<td>VREF_SELECT1</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>20</td>
<td>1</td>
<td>JP14</td>
<td>VREF_SELECT2</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikey</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>21</td>
<td>1</td>
<td>J1</td>
<td>VA_EXT</td>
<td>CONN JACK BANANA UNINS PANEL MOU</td>
<td>Digikey</td>
<td>J147-ND</td>
</tr>
<tr>
<td>22</td>
<td>3</td>
<td>J2,J6,J12</td>
<td>GND</td>
<td>CONN JACK BANANA UNINS PANEL MOU</td>
<td>Digikey</td>
<td>J147-ND</td>
</tr>
<tr>
<td>23</td>
<td>1</td>
<td>J3</td>
<td>VIO_EXT</td>
<td>CONN JACK BANANA UNINS PANEL MOU</td>
<td>Digikey</td>
<td>J147-ND</td>
</tr>
<tr>
<td>24</td>
<td>1</td>
<td>J4</td>
<td>THERMOCOUPLE</td>
<td>THERMOCOUPLE CLASS K SOCKET</td>
<td>RS Mobile</td>
<td>381-7564</td>
</tr>
<tr>
<td>25</td>
<td>1</td>
<td>J5</td>
<td>VIN0</td>
<td>CONN JACK BANANA UNINS PANEL MOU</td>
<td>Digikey</td>
<td>J147-ND</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>---</td>
<td>---</td>
<td>---</td>
<td>---</td>
<td>---</td>
<td></td>
<td></td>
</tr>
<tr>
<td>28</td>
<td>1</td>
<td>J7</td>
<td>VIN1</td>
<td>CONN JACK BANANA UNINS PANEL MOU</td>
<td>Digikee</td>
<td>J147-ND</td>
</tr>
<tr>
<td>29</td>
<td>1</td>
<td>J8</td>
<td>SPI_PROBE</td>
<td>CONN HEADER .100 SINGL STR 36POS</td>
<td>Digikee</td>
<td>S1011E-36-ND</td>
</tr>
<tr>
<td>30</td>
<td>1</td>
<td>J9</td>
<td>EXT_CLK</td>
<td>CONN BNC FEM JACK PC MNT STRGHT</td>
<td>Digikee</td>
<td>ACX1051-ND</td>
</tr>
<tr>
<td>31</td>
<td>1</td>
<td>J10</td>
<td>RTD</td>
<td>TERM BLOCK PCB 4POS 5.0MM GREEN</td>
<td>Digikee</td>
<td>277-1579-ND</td>
</tr>
<tr>
<td>32</td>
<td>1</td>
<td>J11</td>
<td>VREFP_EXT</td>
<td>CONN JACK BANANA UNINS PANEL MOU</td>
<td>Digikee</td>
<td>J147-ND</td>
</tr>
<tr>
<td>33</td>
<td>1</td>
<td>J13</td>
<td>VREFN_EXT</td>
<td>CONN JACK BANANA UNINS PANEL MOU</td>
<td>Digikee</td>
<td>J147-ND</td>
</tr>
<tr>
<td>34</td>
<td>4</td>
<td>L1,L2,L3,L4</td>
<td>100 uH</td>
<td>INDUCTOR 100UH 140MA 10% SMD</td>
<td>Digikee</td>
<td>587-2038-1-ND</td>
</tr>
<tr>
<td>35</td>
<td>4</td>
<td>R5,R19,R21,RREF</td>
<td>1k, 0.1%</td>
<td>RES 1.0K OHM 1/8W .1% 0805 SMD</td>
<td>Digikee</td>
<td>RG20P1.0KBCT-ND</td>
</tr>
<tr>
<td>36</td>
<td>4</td>
<td>RRTD1,RRTD2,R22,R23</td>
<td>0</td>
<td>RES 0.0 OHM 1/10W 0603 SMD</td>
<td>Digikee</td>
<td>RMCF1/160RCT-ND</td>
</tr>
<tr>
<td>37</td>
<td>5</td>
<td>R1,R2,R3,R4,R17</td>
<td>2k, 0.1%</td>
<td>RES 2.0K OHM 1/8W .1% 0805 SMD</td>
<td>Digikee</td>
<td>P2.0KDACT-ND</td>
</tr>
<tr>
<td>38</td>
<td>11</td>
<td>R6,R7,R8,R9,R10,R11,R12, R13,R14,R15,R16</td>
<td>1M</td>
<td>RES 1.0M OHM 1/8W 5% 0805 SMD</td>
<td>Digikee</td>
<td>RHM1.0MARCT-ND</td>
</tr>
<tr>
<td>39</td>
<td>3</td>
<td>R18,R20,R25</td>
<td>51</td>
<td>RES 51 OHM 1/10W 5% 0603 SMD</td>
<td>Digikee</td>
<td>P51GCT-ND</td>
</tr>
<tr>
<td>41</td>
<td>17</td>
<td>TP1,TP2,TP3,TP4,TP5,TP6, TP7,TP8,TP9,TP10,TP11, TP12,TP13,TP14,TP15,TP16, TP17</td>
<td>GND</td>
<td>TEST POINT PC MULTI PURPOSE BLK</td>
<td>Digikee</td>
<td>5011K-ND</td>
</tr>
<tr>
<td>42</td>
<td>1</td>
<td>U1</td>
<td>LM94022BIMG</td>
<td>ANALOG TEMPERATURE SENSOR</td>
<td>NSC</td>
<td>LM94022BIMG</td>
</tr>
<tr>
<td>43</td>
<td>1</td>
<td>U2</td>
<td>LMP90100</td>
<td>LMP90100</td>
<td>NSC</td>
<td>LMP90100</td>
</tr>
<tr>
<td>44</td>
<td>1</td>
<td>U3</td>
<td>24C02 EEPROM</td>
<td>EEPROM 256x8</td>
<td>Mouser</td>
<td>579-24C02CSN</td>
</tr>
<tr>
<td>45</td>
<td>1</td>
<td>U4</td>
<td>LM4140C-4.1</td>
<td>4.1 V Voltage Reference</td>
<td>NSC</td>
<td>LM4140C-4.1</td>
</tr>
<tr>
<td>46</td>
<td>1</td>
<td>Y1</td>
<td>3.57 MHz</td>
<td>CRYS TAL 3.579545 MHZ 18PF 49US</td>
<td>Digikee</td>
<td>XC1707-ND</td>
</tr>
<tr>
<td>47</td>
<td>4</td>
<td>N/A</td>
<td>N/A</td>
<td>BUMPON HEMISPHERE .44X.20 BLACK</td>
<td>Digikee</td>
<td>SJ5003-0-ND</td>
</tr>
</tbody>
</table>

Table 5 - BOM
Texas Instruments (TI) provides the enclosed Evaluation Board/Kit/Module (EVM) under the following conditions: The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods.

Should this evaluation board/kit not meet the specifications indicated in the User’s Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING LIMITED WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE. EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please visit www.ti.com/esh or contact TI.

No license is granted under any patent right or other intellectual property right of TI covering or relating to any machine, process, or combination in which such TI products or services might be or are used. TI currently deals with a variety of customers for products, and therefore our arrangement with the user is not exclusive. TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein.

REGULATORY COMPLIANCE INFORMATION

As noted in the EVM User’s Guide and/or EVM itself, this EVM and/or accompanying hardware may or may not be subject to the Federal Communications Commission (FCC) and Industry Canada (IC) rules.

For EVMs not subject to the above rules, this evaluation board/kit/module is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or ICES-003 rules, which are designed to provide reasonable protection against radio frequency interference. Operation of the equipment may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

General Statement for EVMs including a radio

User Power/Frequency Use Obligations: This radio is intended for development/professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability of this EVM and its development application(s) must comply with local laws governing radio spectrum allocation and power limits for this evaluation module. It is the user’s sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by Texas Instruments unless user has obtained appropriate experimental/development licenses from local regulatory authorities, which is responsibility of user including its acceptable authorization.

For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

Caution
This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices
This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

**FCC Interference Statement for Class B EVM devices**
This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

**For EVMs annotated as IC – INDUSTRY CANADA Compliant**
This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user’s authority to operate the equipment.

**Concerning EVMs including radio transmitters**
This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

**Concerning EVMs including detachable antennas**
Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l’autorité de l’utilisateur pour actionner l’équipement.

**Concernant les EVMs avec appareils radio**
Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

**Concernant les EVMs avec antennes détaçables**
Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but
de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

【Important Notice for Users of this Product in Japan】
This development kit is NOT certified as Confirming to Technical Regulations of Radio Law of Japan

If you use this product in Japan, you are required by Radio Law of Japan to follow the instructions below with respect to this product:

1. Use this product in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry’s Rule for Enforcement of Radio Law of Japan,
2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

Texas Instruments Japan Limited
(address) 24-1, Nishi-Shinjuku 6 chome, Shinjuku-ku, Tokyo, Japan

http://www.tij.co.jp

【ご使用にあたっての注】
本開発キットは技術基準適合証明を受けておりません。本製品のご使用に際しては、電波法遵守のため、以下のいずれかの措置を取っていただく必要がありますのでご注意ください。

1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。

上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。

日本テキサス・インスツルメンツ株式会社
東京都新宿区西新宿6丁目24番1号
西新宿三井ビル
http://www.tij.co.jp
EVALUATION BOARD/KIT/MODULE (EVM)
WARNINGS, RESTRICTIONS AND DISCLAIMERS

For Feasibility Evaluation Only, in Laboratory/Development Environments. Unless otherwise indicated, this EVM is not a finished electrical equipment and not intended for consumer use. It is intended solely for use for preliminary feasibility evaluation in laboratory/development environments by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems and subsystems. It should not be used as all or part of a finished end product.

Your Sole Responsibility and Risk. You acknowledge, represent and agree that:

1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.

2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.

3. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.

4. You will take care of proper disposal and recycling of the EVM’s electronic components and packing materials.

Certain Instructions. It is important to operate this EVM within TI's recommended specifications and environmental considerations per the user guidelines. Exceeding the specified EVM ratings (including but not limited to input and output voltage, current, power, and environmental ranges) may cause property damage, personal injury or death. If there are questions concerning these ratings please contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during normal operation, please be aware that these devices may be very warm to the touch. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use these EVMs.

Agreement to Defend, Indemnify and Hold Harmless. You agree to defend, indemnify and hold TI, its licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of or in connection with any use of the EVM that is not in accordance with the terms of the agreement. This obligation shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if the EVM fails to perform as described or expected.

Safety-Critical or Life-Critical Applications. If you intend to evaluate the components for possible use in safety critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, such as devices which are classified as FDA Class III or similar classification, then you must specifically notify TI of such intent and enter into a separate Assurance and Indemnity Agreement.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2012, Texas Instruments Incorporated
IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD48B and to discontinue any product or service per JESD48B. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as “components”) are sold subject to TI’s terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI’s terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers’ products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers’ products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI’s goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or “enhanced plastic” are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have not been so designated is solely at the Buyer’s risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components which meet ISO/TS16949 requirements, mainly for automotive use. Components which have not been so designated are neither designed nor intended for automotive use; and TI will not be responsible for any failure of such components to meet such requirements.

### Products

<table>
<thead>
<tr>
<th>Audio</th>
<th><a href="http://www.ti.com/audio">www.ti.com/audio</a></th>
</tr>
</thead>
<tbody>
<tr>
<td>Amplifiers</td>
<td>amplifier.ti.com</td>
</tr>
<tr>
<td>Data Converters</td>
<td>dataconverter.ti.com</td>
</tr>
<tr>
<td>DLP® Products</td>
<td><a href="http://www.dlp.com">www.dlp.com</a></td>
</tr>
<tr>
<td>DSP</td>
<td>dsp.ti.com</td>
</tr>
<tr>
<td>Clocks and Timers</td>
<td><a href="http://www.ti.com/clocks">www.ti.com/clocks</a></td>
</tr>
<tr>
<td>Interface</td>
<td>interface.ti.com</td>
</tr>
<tr>
<td>Logic</td>
<td>logic.ti.com</td>
</tr>
<tr>
<td>Power Mgmt</td>
<td>power.ti.com</td>
</tr>
<tr>
<td>Microcontrollers</td>
<td>microcontroller.ti.com</td>
</tr>
<tr>
<td>RFID</td>
<td><a href="http://www.ti-rfid.com">www.ti-rfid.com</a></td>
</tr>
<tr>
<td>OMAP Mobile Processors</td>
<td><a href="http://www.ti.com/omap">www.ti.com/omap</a></td>
</tr>
<tr>
<td>Wireless Connectivity</td>
<td><a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a></td>
</tr>
</tbody>
</table>

### Applications

<table>
<thead>
<tr>
<th>Automotive and Transportation</th>
<th><a href="http://www.ti.com/automotive">www.ti.com/automotive</a></th>
</tr>
</thead>
<tbody>
<tr>
<td>Communications and Telecom</td>
<td><a href="http://www.ti.com/communications">www.ti.com/communications</a></td>
</tr>
<tr>
<td>Computers and Peripherals</td>
<td><a href="http://www.ti.com/computers">www.ti.com/computers</a></td>
</tr>
<tr>
<td>Consumer Electronics</td>
<td><a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a></td>
</tr>
<tr>
<td>Energy and Lighting</td>
<td><a href="http://www.ti.com/energy">www.ti.com/energy</a></td>
</tr>
<tr>
<td>Industrial</td>
<td><a href="http://www.ti.com/industrial">www.ti.com/industrial</a></td>
</tr>
<tr>
<td>Medical</td>
<td><a href="http://www.ti.com/medical">www.ti.com/medical</a></td>
</tr>
<tr>
<td>Security</td>
<td><a href="http://www.ti.com/security">www.ti.com/security</a></td>
</tr>
<tr>
<td>Space, Avionics and Defense</td>
<td><a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a></td>
</tr>
<tr>
<td>Video and Imaging</td>
<td><a href="http://www.ti.com/video">www.ti.com/video</a></td>
</tr>
</tbody>
</table>

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2012, Texas Instruments Incorporated